

N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent Rds(ON) with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

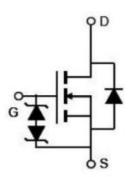
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS&Halogen compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V _{DS min@Tjmax}	650	V
R _{DS(ON)TYP} .	380	mΩ
I_D	10	Α
Qg	13.7	nC



Schematic diagram

♦ Intrinsic fast-recovery body diode

Package Marking And Ordering Information

Device	Device Package	Marking	
NCE60NF420	TO-220	NCE60NF420	



TO-220

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Table 1. Absolute Maximum Ratings (T_c=25°C)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	600	V
Gate-Source Voltage (V _{DS=0} V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (V _{DS=0} V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	10	A
Continuous Drain Current at Tc=100°C	I _{D (DC)}	7	A
Pulsed drain current (Note 1)	I _{DM (pluse)}	30	А
Maximum Power Dissipation(Tc=25℃)	P _D	96	W
Derate above 25°C		0.64	W/°C
Single pulse avalanche current (Note 2)	I _{AS}	2	A
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	50	V/ns
Drain Source voltage slope,V _{DS} ≤480 V	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55+175	°C



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	1.56	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62	°C /W

 Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	600			V
Zero Gate Voltage Drain Current(Tc=25°ℂ)	I _{DSS}	V _{DS} =600V,V _{GS} =0V			10	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =600V,V _{GS} =0V			300	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±200	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250uA$	3.5	4.2	5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5A		380	420	mΩ
Dynamic Characteristics				'		
Gate Resistance	Rg	F=1MHZ, D-S short		41		Ω
Input Capacitance	C _{iss}	., 50,414 014		591		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		17		pF
Reverse Transfer Capacitance	C _{rss}	F=1MHz		1.9		pF
Total Gate Charge	Qg			13.7	15	nC
Gate-Source Charge	Q _{gs}	V _{DS} =400V,I _D =5A, V _{GS} =10V		3.3		nC
Gate-Drain Charge	Q _{gd}			6.9		nC
Gate plateau voltage	Vgp			7.2		V
Switching times						
Turn-on Delay Time	t _{d(on)}			16		nS
Turn-on Rise Time	tr	V_{DD} =380 V , I_{D} =5 A ,		12		nS
Turn-Off Delay Time	t _{d(off)}	R_G =4 Ω , V_{GS} =10 V		50		nS
Turn-Off Fall Time	t _f			9		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T 05°0			10	Α
Pulsed-Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			30	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =10A,V _{GS} =0V		1.0	1.2	V
Reverse Recovery Time	t _{rr}			80		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I _{F=} 5A,		0.24		uC
Peak reverse recovery current	I _{rrm}	di/dt=100A/µs		6		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^{\circ}$ C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

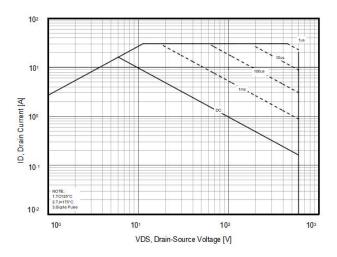


Figure 2. Source-Drain Diode Forward Voltage

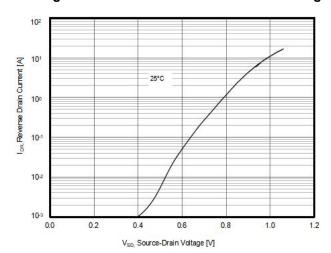


Figure 3. Transfer characteristics

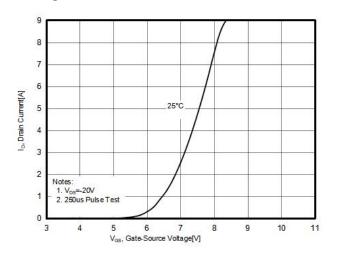


Figure 4. Output characteristics

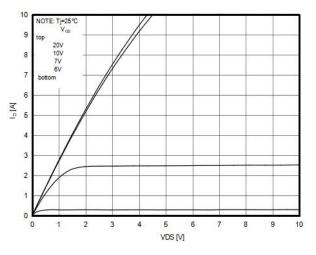


Figure 5. Static drain-source on resistance

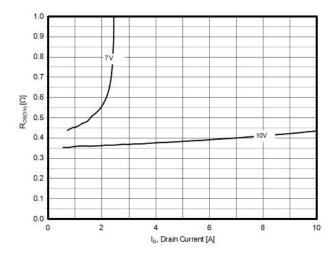
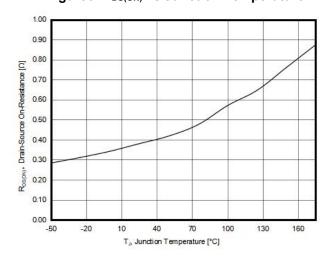


Figure 6. RDS(ON) vs Junction Temperature



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Figure 7. BV_{DSS} vs Junction Temperature

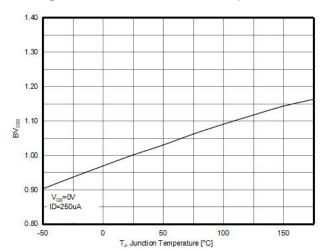


Figure 8. Maximum I_D vs Junction Temperature

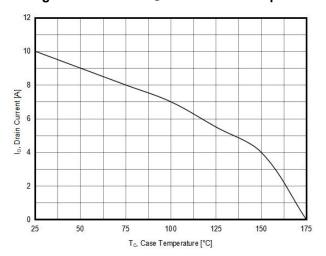


Figure 9. Gate charge waveforms

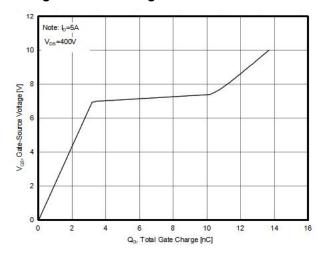
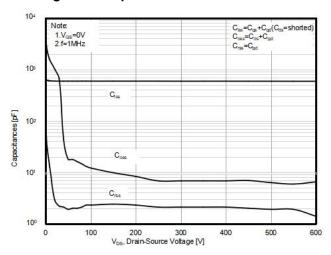


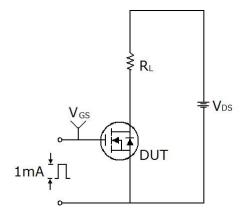
Figure 10. Capacitance

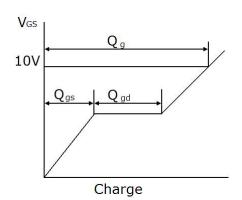




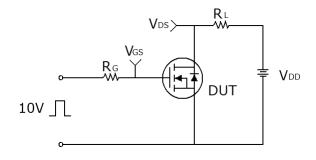
Test circuit

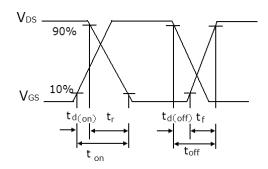
1) Gate charge test circuit & Waveform



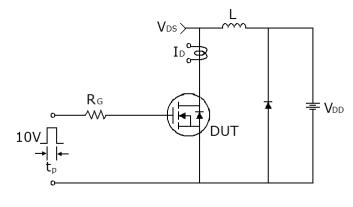


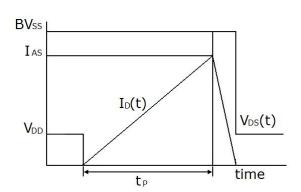
2) Switch Time Test Circuit:





3) Unclamped Inductive Switching Test Circuit & Waveforms

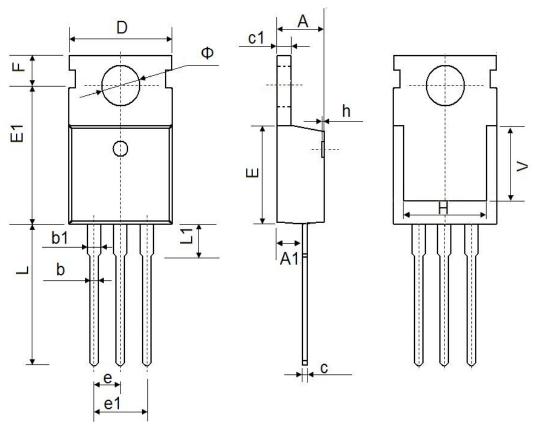




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TO-220-3L-E Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Зушьог	Min.	Max.	Min.	Max.	
Α	4.20	4.60	0.165	0.181	
A1	2.25	2.55	0.089	0.100	
b	0.70	0.90	0.028	0.035	
b1	1.17	1.37	0.046	0.054	
С	0.33	0.65	0.013	0.026	
c1	1.20	1.40	0.047	0.055	
D	8.95	9.75	0.352	0.384	
E	9.74	10.04	0.352	0.384	
E1	9.91	10.25	0.390	0.404	
е	2.54	BSC	0.100	OBSC	
e1	5.08	5.08BSC		OBSC	
Н	15.45	15.85	0.608	0.624	
L	12.90	13.40	0.508	0.528	
L1	2.85	3.25	0.112	0.128	
Ф	3.40	3.80	0.134	0.150	



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